

PATENT ASSIGNMENT

Electronic Version v1.1
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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Deepak C. Sekar</td> <td>11/05/2010</td> </tr> <tr> <td>Franz Kreupl</td> <td>11/05/2010</td> </tr> <tr> <td>Raghuveer Makala</td> <td>11/05/2010</td> </tr> <tr> <td>Peter Rabkin</td> <td>11/05/2010</td> </tr> </tbody> </table>		Name	Execution Date	Deepak C. Sekar	11/05/2010	Franz Kreupl	11/05/2010	Raghuveer Makala	11/05/2010	Peter Rabkin	11/05/2010
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RECEIVING PARTY DATA											
<table border="1"> <tr> <td>Name:</td> <td>SanDisk 3D LLC</td> </tr> <tr> <td>Street Address:</td> <td>951 SanDisk Drive</td> </tr> <tr> <td>City:</td> <td>Milpitas</td> </tr> <tr> <td>State/Country:</td> <td>CALIFORNIA</td> </tr> <tr> <td>Postal Code:</td> <td>95035</td> </tr> </table>		Name:	SanDisk 3D LLC	Street Address:	951 SanDisk Drive	City:	Milpitas	State/Country:	CALIFORNIA	Postal Code:	95035
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PROPERTY NUMBERS Total: 1											
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CORRESPONDENCE DATA											
<p>Fax Number: 4154894150 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 4154894100</p> <p>Email: rkerrigan@vierramagen.com</p> <p>Correspondent Name: Vierra Magen Marcus LLP</p> <p>Address Line 1: 575 Market Street</p> <p>Address Line 2: Suite 3750</p> <p>Address Line 4: San Francisco, CALIFORNIA 94105</p>											
ATTORNEY DOCKET NUMBER:	SAND-01460US2 (SDUF)										
NAME OF SUBMITTER:	Rebekah Kerrigan										
Total Attachments: 7											

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JOINT TO CORPORATE ASSIGNMENT

WHEREAS, the undersigned Inventors:

Deepak C. Sekar, a resident of Sunnyvale, California;

Franz Kreupl, a resident of Mountain View, California;

Raghuveer Makala, a resident of Milpitas, California;

Peter Rabkin, a resident of Cupertino, California;

Chu-Chen Fu, a resident of San Ramon, California; and

Tong Zhang, a resident of Milpitas, California.

have invented certain new and useful improvements in:

NON-VOLATILE STORAGE WITH METAL OXIDE SWITCHING ELEMENT AND METHODS FOR FABRICATING THE SAME

and have executed a declaration for an application for a United States Patent disclosing and identifying the invention, the declaration being executed on 11/05/2010; 11/08/2010.

WHEREAS SanDisk 3D LLC (hereinafter termed "Assignee"), a corporation of the State of Delaware, having a place of business at 601 McCarthy Boulevard, Milpitas, State of California, wishes to acquire the entire right, title and interest in and to said application and the invention disclosed therein, and in and to all embodiments of the invention, heretofore conceived, made or discovered jointly or severally by said Inventors (all collectively hereinafter termed "said invention"), and in and to any and all patents, certificates of invention and other forms of protection thereon (hereinafter termed "patents") applied for or granted in the United States and/or other countries.

NOW THEREFORE, for good and valuable consideration acknowledged by each of said Inventors to have been received in full from said Assignee:

1. Said Inventors do hereby sell, assign, transfer and convey to said Assignee, the entire right, title and interest (a) in and to said application and said invention; (b) in and to all rights to apply in any or all countries of the world for patents, certificates of inventions or other governmental grants on said invention, including the right to apply for patents pursuant to the International Convention for the Protection of Industrial Property or pursuant to any other convention, treaty, agreement or understanding; (c) in and to any and all applications filed and any and all patents, certificates of inventions or other governmental grants granted on said

invention in the United States or any other country, including each and every application filed and each and every patent granted on any application which is a division, substitution, or continuation of any of said applications; (d) in and to each and every reissue or extension of any of said patents; and (e) in and to each and every patent claim resulting from a reexamination certificate for any and all of said patents.

2. Said Inventors hereby jointly and severally covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest herein conveyed in the United States and other countries. Such cooperation by said Inventors shall include prompt production of pertinent facts and documents, giving of testimony, executing of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for complying with any duty of disclosure; (c) for prosecuting any of said applications; (d) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (e) for filing and prosecuting applications for reissue of any of said patents; (f) for interference or other priority proceedings involving said invention; and (g) for legal proceedings involving said invention and any applications therefor and any patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, reexamination proceedings, compulsory licensing proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventors in providing such cooperation shall be paid for by said Assignee.

3. The terms and covenants of this Assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventors, their respective heirs, legal representatives and assigns.

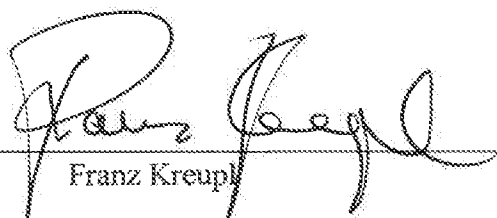
4. Said Inventors hereby jointly and severally warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

Date: 11/5/10

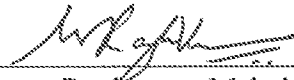
Deepak C. Sekar
Deepak C. Sekar

Date:

Nov. 5, 2010


Franz Kreup

Date: 11/05/2010


Raghuvir Makala

Date:

11/05/2010

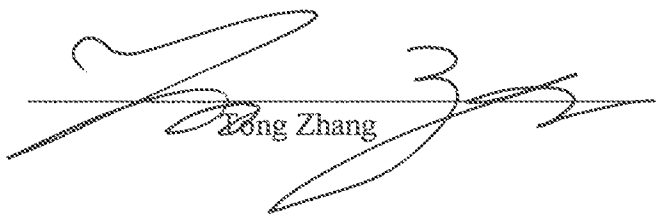

Peter Rabkin

Date: 11/5/2010

Chu-Chen Fu
Chu-Chen Fu

Date:

11/8/2010


Long Zhang